

March 2012
SuperFET® II

## FCP380N60 / FCPF380N60

## 600V N-Channel MOSFET

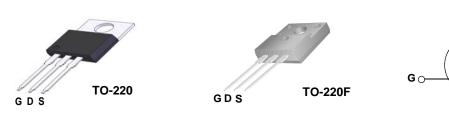
### **Features**

- 650V @T<sub>.I</sub> = 150°C
- Max.  $R_{DS(on)} = 380 m\Omega$
- Ultra low gate charge (typ. Q<sub>g</sub> = 30nC)
- Low effective output capacitance (typ. C<sub>oss</sub>.eff = 95pF)
- 100% avalanche tested

## **Description**

SuperFET®II is, Fairchild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET<sup>®</sup>II is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.



## Absolute Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted

Symbol		Parameter		FCP380N60	FCPF380N60	Units
V <sub>DSS</sub>	Drain to Source Voltage			600		V
V	Gate to Source Voltage	-DC		±	20	V
$V_{GSS}$	Gate to Source voltage	-AC	(f>1HZ)	±	30	V
	Drain Current	-Continuous (T <sub>C</sub> = 25°C)		10.2	10.2*	Α
ID	Drain Current	-Continuous (T <sub>C</sub> = 100°C)		6.4	6.4*	А
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	30.6	30.6*	Α
E <sub>AS</sub>	Single Pulsed Avalanche Ene	Single Pulsed Avalanche Energy (Note 2)		211.6		mJ
I <sub>AR</sub>	Avalanche Current (N		(Note 1)	2.3		Α
E <sub>AR</sub>	Repetitive Avalanche Energy	Repetitive Avalanche Energy (No		1.06		mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	3) 20		V/ns
αν/αι	MOSFET dv/dt			1	00	V/IIS
D	Dower Discipation	$(T_C = 25^{\circ}C)$		106	31	W
$P_{D}$	Power Dissipation	- Derate above 25°C		0.85	0.25	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150		°С	
T <sub>L</sub>	Maximum Lead Temperature 1/8" from Case for 5 Seconds	• .		300		°C

<sup>\*</sup>Drain current limited by maximum junction temperature

## **Thermal Characteristics**

Symbol	Parameter	FCP380N60	FCPF380N60	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.18	4	
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.5	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	

## **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCP380N60	FCP380N60	TO-220	-	-	50
FCPF380N60	FCPF380N60	TO-220F	-	-	50

# **Electrical Characteristics** $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Charac	cteristics					
B\/	Drain to Source Breakdown Voltage	$V_{GS} = 0V, I_D = 10mA, T_J = 25^{\circ}C$	600	-	-	V
BV <sub>DSS</sub> Dra	Jiain to Source Breakdown voltage	$V_{GS} = 0V, I_D = 10mA, T_J = 150^{\circ}C$	650	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 10mA, Referenced to 25°C	-	0.6	-	V/°C
BV <sub>DS</sub>	Drain-Source Avalanche Breakdown Voltage	$V_{GS} = 0V, I_D = 10A$	-	700	-	V
	Zero Gate Voltage Drain Current	$V_{DS} = 480V, V_{GS} = 0V$	-	-	1	
DSS	Zero Gate voltage Drain Current	$V_{DS} = 480V, T_{C} = 125^{\circ}C$	-	-	10	μΑ
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	±100	nA

#### On Characteristics

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.5	-	3.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 5A$	•	0.33	0.38	Ω
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 20V, I_{D} = 5A$	ı	11		S

## **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V 05V V 0V	-	1250	1665	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 25V, V_{GS} = 0V$ f = 1MHz		905	1205	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			45	60	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 380V, V_{GS} = 0V, f = 1.0MHz$	-	23	-	pF
Coss eff.	Effective Output Capacitance	$V_{DS} = 0V$ to 480V, $V_{GS} = 0V$	-	95	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10V	$V_{DS} = 380V, I_{D} = 5A$	-	30	40	nC
$Q_{gs}$	Gate to Source Gate Charge	V <sub>GS</sub> = 10V	-	5	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge	(Note 4)	-	10	-	nC
ESR	Equivalent Series Resistance	Drain Open		1		Ω

## **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time			-	14	38	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{DD} = 380V, I_{D} = 5A$		-	7	24	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10V, R = 4.7\Omega$		-	45	100	ns
t <sub>f</sub>	Turn-Off Fall Time		(Note 4)	-	6	22	ns

### **Drain-Source Diode Characteristics**

IS	Maximum Continuous Drain to Source Diode Forward Current		-	-	10.2	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	30.6	Α
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0V$ , $I_{SD} = 5A$	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0V, I_{SD} = 5A$	-	240	-	ns
$Q_{rr}$	Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	-	2.7	-	μС

#### Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2.  $I_{AS}$  = 2.3A,  $V_{DD}$  = 50V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25 $^{\circ}C$
- 3.  $I_{SD} \le 5.1 A$ , di/dt  $\le 200 A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$
- 4. Essentially Independent of Operating Temperature Typical Characteristics

## **Typical Performance Characteristics**

Figure 1. On-Region Characteristics

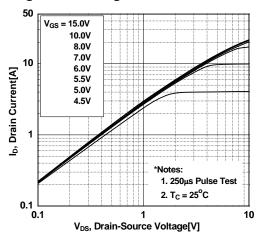


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

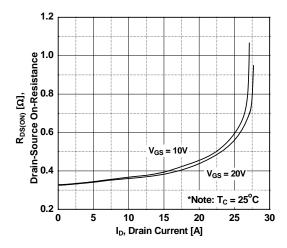


Figure 5. Capacitance Characteristics

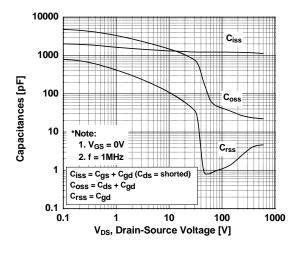


Figure 2. Transfer Characteristics

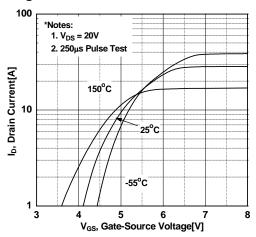


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

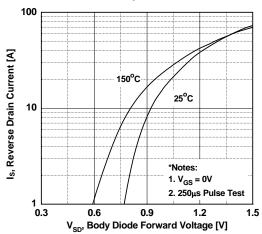
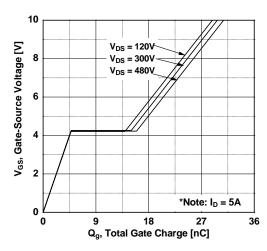


Figure 6. Gate Charge Characteristics



## **Typical Performance Characteristics** (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

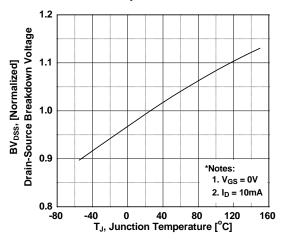


Figure 9. Maximum Safe Operating Area vs. Case Temperature - FCP380N60

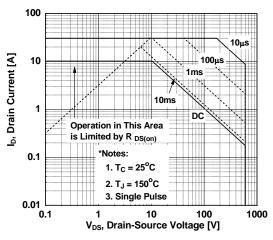


Figure 11. Maximum Drain Current

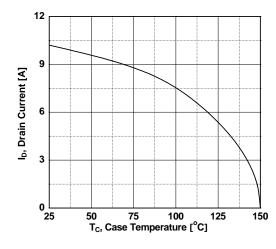


Figure 8. On-Resistance Variation vs. Temperature

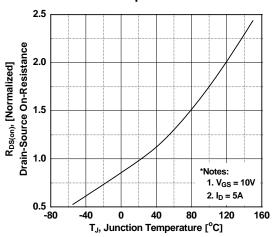


Figure 10. Maximum Safe Operating Area vs. Case Temperature - FCPF380N60

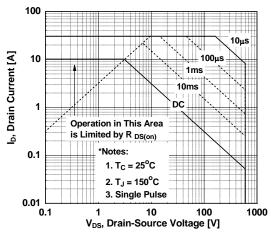
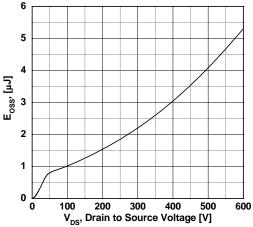


Figure 12. Eoss vs. Drain to Source Voltage Switching Capability



## **Typical Performance Characteristics** (Continued)

Figure 13. Transient Thermal Response Curve - FCP380N60

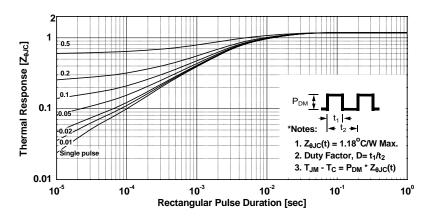
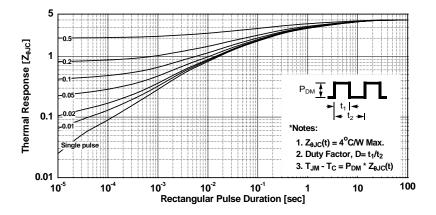
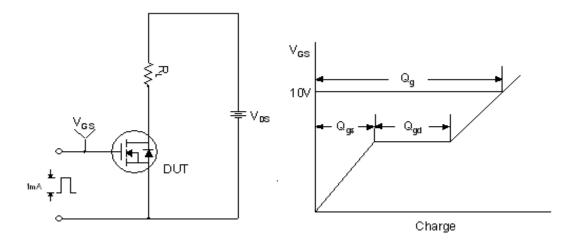


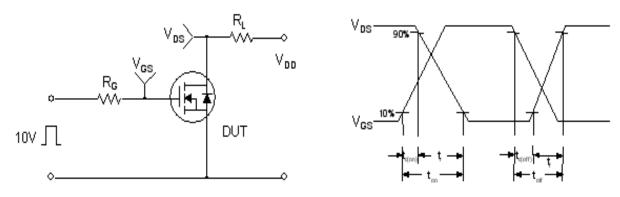
Figure 14. Transient Thermal Response Curve - FCPF380N60



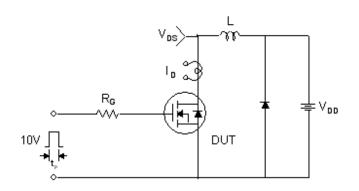
## **Gate Charge Test Circuit & Waveform**

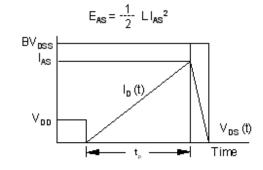


## **Resistive Switching Test Circuit & Waveforms**

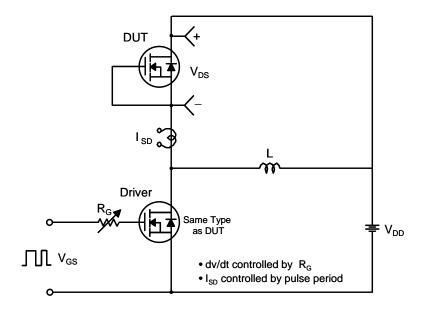


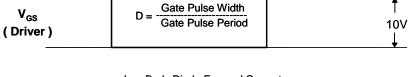
## **Unclamped Inductive Switching Test Circuit & Waveforms**

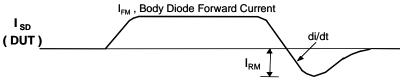


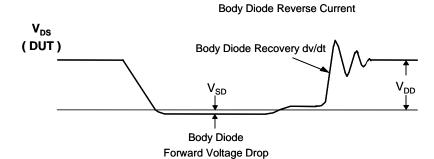


### Peak Diode Recovery dv/dt Test Circuit & Waveforms



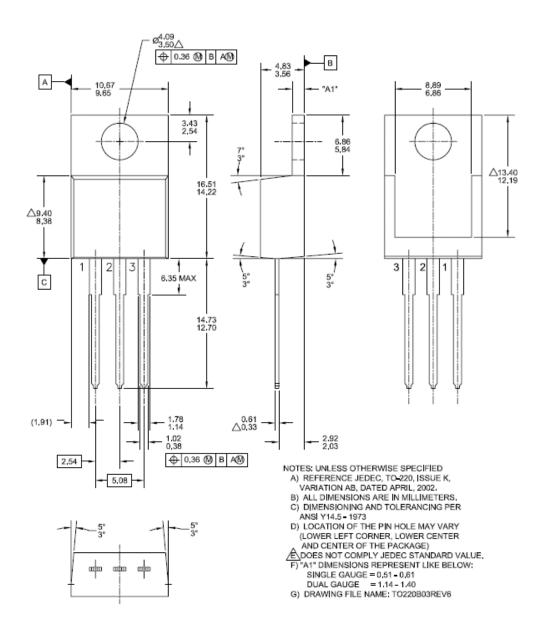






## **Mechanical Dimensions**

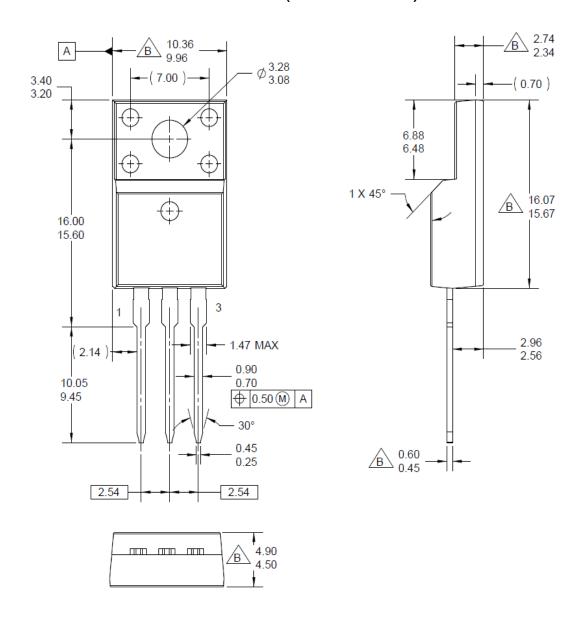
# TO-220



Dimensions in Millimeters

## **Package Dimensions**

# TO-220F (Retractable)



\* Front/Back Side Isolation Voltage : AC 2500V

Dimensions in Millimeters





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